

DATA SHEET

74LV02

Quad 2-input NOR gate

Product specification

1997 Feb 03

IC24 Data Handbook

Quad 2-input NOR gate

74LV02

FEATURES

- Wide operating voltage: 1.0 to 5.5 V
- Optimized for low voltage applications: 1.0 to 5.5 V
- Accepts TTL input levels between $V_{CC} = 2.7$ V and $V_{CC} = 3.6$ V
- Typical V_{OLP} (output ground bounce) < 0.8 V at $V_{CC} = 3.3$ V, $T_{amb} = 25^{\circ}\text{C}$
- Typical V_{OHV} (output V_{OH} undershoot) > 2 V at $V_{CC} = 3.3$ V, $T_{amb} = 25^{\circ}\text{C}$
- Output capability: standard
- I_{CC} category: SSI

DESCRIPTION

The 74LV02 is a low-voltage Si-gate CMOS device that is pin and function compatible with 74HC/HCT02.

The 74LV02 provides the 2-input NOR function.

QUICK REFERENCE DATA

GND = 0 V; $T_{amb} = 25^{\circ}\text{C}$; $t_r = t_f \leq 2.5$ ns

| SYMBOL | PARAMETER | CONDITIONS | TYPICAL | UNIT |
|-------------------|--|------------------------------------|---------|------|
| t_{PHL}/t_{PLH} | Propagation delay nA, nB to nY | $C_L = 15$ pF; $V_{CC} = 3.3$ V | 6 | ns |
| C_I | Input capacitance | | 3.5 | pF |
| C_{PD} | Power dissipation capacitance per gate | See Notes 1 and 2 | 22 | pF |

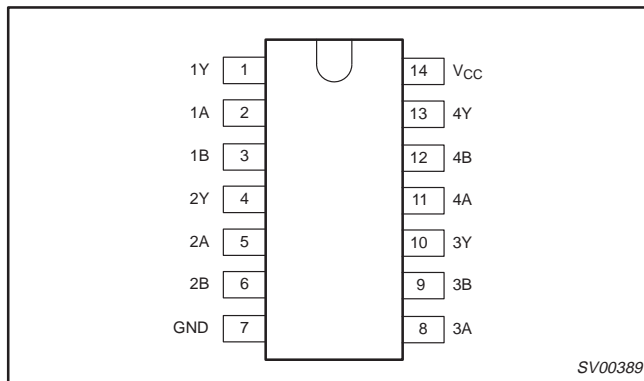
NOTES:

1. C_{PD} is used to determine the dynamic power dissipation (P_D in μW)
 $P_D = C_{PD} \times V_{CC}^2 \times f_i + \sum (C_L \times V_{CC}^2 \times f_o)$ where:
 f_i = input frequency in MHz; C_L = output load capacity in pF;
 f_o = output frequency in MHz; V_{CC} = supply voltage in V;
 $\sum (C_L \times V_{CC}^2 \times f_o)$ = sum of the outputs.
2. The condition is V_1 is $V_1 = \text{GND to } V_{CC}$.

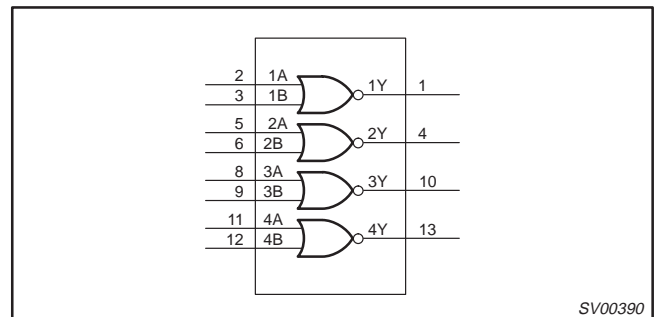
ORDERING INFORMATION

| PACKAGES | TEMPERATURE RANGE | OUTSIDE NORTH AMERICA | NORTH AMERICA | PKG. DWG. # |
|-----------------------------|-------------------|-----------------------|---------------|-------------|
| 14-Pin Plastic DIL | -40°C to +125°C | 74LV02 N | 74LV02 N | SOT27-1 |
| 14-Pin Plastic SO | -40°C to +125°C | 74LV02 D | 74LV02 D | SOT108-1 |
| 14-Pin Plastic SSOP Type II | -40°C to +125°C | 74LV02 DB | 74LV02 DB | SOT337-1 |
| 14-Pin Plastic TSSOP Type I | -40°C to +125°C | 74LV02 PW | 74LV02PW DH | SOT402-1 |

PIN CONFIGURATION



LOGIC SYMBOL



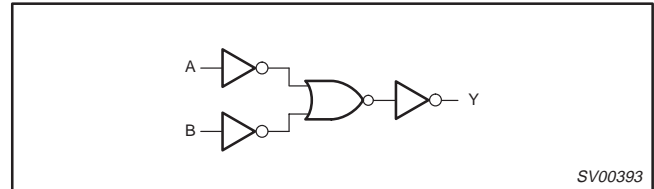
Quad 2-input NOR gate

74LV02

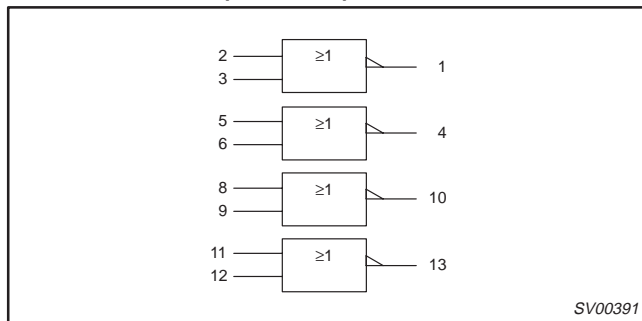
PIN DESCRIPTION

| PIN NUMBER | SYMBOL | FUNCTION |
|--------------|-----------------|-------------------------|
| 1, 4, 10, 13 | 1Y – 4Y | Data outputs |
| 2, 5, 8, 11 | 1A – 4A | Data inputs |
| 3, 6, 9, 12 | 1B – 4B | Data inputs |
| 7 | GND | Ground (0 V) |
| 14 | V _{CC} | Positive supply voltage |

LOGIC DIAGRAM (ONE GATE)



LOGIC SYMBOL (IEEE/IEC)



FUNCTION TABLE

| INPUTS | | OUTPUTS |
|--------|----|---------|
| nA | nB | nY |
| L | L | H |
| L | H | L |
| H | L | L |
| H | H | L |

NOTES:

- H = HIGH voltage level
- L = LOW voltage level

ABSOLUTE MAXIMUM RATINGS^{1, 2}

In accordance with the Absolute Maximum Rating System (IEC 134).
 Voltages are referenced to GND (ground = 0V).

| SYMBOL | PARAMETER | CONDITIONS | RATING | UNIT |
|---|---|--|-------------------|------|
| V _{CC} | DC supply voltage | | -0.5 to +7.0 | V |
| ±I _{IK} | DC input diode current | V _I < -0.5 or V _I > V _{CC} + 0.5V | 20 | mA |
| ±I _{OK} | DC output diode current | V _O < -0.5 or V _O > V _{CC} + 0.5V | 50 | mA |
| ±I _O | DC output source or sink current - standard outputs - bus driver outputs | -0.5V < V _O < V _{CC} + 0.5V | 25 35 | mA |
| ±I _{GND} , ±I _{CC} | DC V _{CC} or GND current for types with - standard outputs - bus driver outputs | | 50 70 | mA |
| T _{stg} | Storage temperature range | | -65 to +150 | °C |
| P _{TOT} | Power dissipation per package - plastic DIL - plastic mini-pack (SO) - plastic shrink mini-pack (SSOP and TSSOP) | for temperature range: -40 to +125°C above +70°C derate linearly with 12 mW/K above +70°C derate linearly with 8 mW/K above +60°C derate linearly with 5.5 mW/K | 750 500 400 | mW |

NOTES:

1. Stresses beyond those listed may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
2. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

Quad 2-input NOR gate

74LV02

RECOMMENDED OPERATING CONDITIONS

| SYMBOL | PARAMETER | CONDITIONS | MIN | TYP. | MAX | UNIT |
|------------|---|--|------------------|------------------|-------------------------|------|
| V_{CC} | DC supply voltage | See Note 1 | 1.0 | 3.3 | 5.5 | V |
| V_I | Input voltage | | 0 | – | V_{CC} | V |
| V_O | Output voltage | | 0 | – | V_{CC} | V |
| T_{amb} | Operating ambient temperature range in free air | See DC and AC characteristics per device | –40 –40 | | +85 +125 | °C |
| t_r, t_f | Input rise and fall times except for Schmitt-trigger inputs | $V_{CC} = 1.0V$ to $2.0V$ $V_{CC} = 2.0V$ to $2.7V$ $V_{CC} = 2.7V$ to $3.6V$ $V_{CC} = 3.6V$ to $5.5V$ | – – – – | – – – – | 500 200 100 50 | ns/V |

NOTE:

1. The LV is guaranteed to function down to $V_{CC} = 1.0V$ (input levels GND or V_{CC}); DC characteristics are guaranteed from $V_{CC} = 1.2V$ to $V_{CC} = 5.5V$.

DC ELECTRICAL CHARACTERISTICS

Over recommended operating conditions. Voltages are referenced to GND (ground = 0V).

| SYMBOL | PARAMETER | TEST CONDITIONS | LIMITS | | | | | UNIT |
|----------|---|--|--------------------|-------------------|--------------------|--------------------|--------------------|---------|
| | | | –40°C to +85°C | | | –40°C to +125°C | | |
| | | | MIN | TYP. ¹ | MAX | MIN | MAX | |
| V_{IH} | HIGH level Input voltage | $V_{CC} = 1.2V$ | 0.9 | | | 0.9 | | V |
| | | $V_{CC} = 2.0V$ | 1.4 | | | 1.4 | | |
| | | $V_{CC} = 2.7$ to $3.6V$ | 2.0 | | | 2.0 | | |
| | | $V_{CC} = 4.5$ to $5.5V$ | $0.7 \cdot V_{CC}$ | | | $0.7 \cdot V_{CC}$ | | |
| V_{IL} | LOW level Input voltage | $V_{CC} = 1.2V$ | | | 0.3 | | 0.3 | V |
| | | $V_{CC} = 2.0V$ | | | 0.6 | | 0.6 | |
| | | $V_{CC} = 2.7$ to $3.6V$ | | | 0.8 | | 0.8 | |
| | | $V_{CC} = 4.5$ to $5.5V$ | | | $0.3 \cdot V_{CC}$ | | $0.3 \cdot V_{CC}$ | |
| V_{OH} | HIGH level output voltage; all outputs | $V_{CC} = 1.2V; V_I = V_{IH}$ or $V_{IL}; -I_O = 100\mu A$ | | 1.2 | | | | V |
| | | $V_{CC} = 2.0V; V_I = V_{IH}$ or $V_{IL}; -I_O = 100\mu A$ | 1.8 | 2.0 | | 1.8 | | |
| | | $V_{CC} = 2.7V; V_I = V_{IH}$ or $V_{IL}; -I_O = 100\mu A$ | 2.5 | 2.7 | | 2.5 | | |
| | | $V_{CC} = 3.0V; V_I = V_{IH}$ or $V_{IL}; -I_O = 100\mu A$ | 2.8 | 3.0 | | 2.8 | | |
| | | $V_{CC} = 4.5V; V_I = V_{IH}$ or $V_{IL}; -I_O = 100\mu A$ | 4.3 | 4.5 | | 4.3 | | |
| V_{OH} | HIGH level output voltage; STANDARD outputs | $V_{CC} = 3.0V; V_I = V_{IH}$ or $V_{IL}; -I_O = 6mA$ | 2.40 | 2.82 | | 2.20 | | V |
| | | $V_{CC} = 4.5V; V_I = V_{IH}$ or $V_{IL}; -I_O = 12mA$ | 3.60 | 4.20 | | 3.50 | | |
| V_{OH} | HIGH level output voltage; BUS driver outputs | $V_{CC} = 3.0V; V_I = V_{IH}$ or $V_{IL}; -I_O = 8mA$ | 2.40 | 2.82 | | 2.20 | | V |
| | | $V_{CC} = 4.5V; V_I = V_{IH}$ or $V_{IL}; -I_O = 16mA$ | 3.60 | 4.20 | | 3.50 | | |
| V_{OL} | LOW level output voltage; all outputs | $V_{CC} = 1.2V; V_I = V_{IH}$ or $V_{IL}; I_O = 100\mu A$ | | 0 | | | | V |
| | | $V_{CC} = 2.0V; V_I = V_{IH}$ or $V_{IL}; I_O = 100\mu A$ | | 0 | 0.2 | | 0.2 | |
| | | $V_{CC} = 2.7V; V_I = V_{IH}$ or $V_{IL}; I_O = 100\mu A$ | | 0 | 0.2 | | 0.2 | |
| | | $V_{CC} = 3.0V; V_I = V_{IH}$ or $V_{IL}; I_O = 100\mu A$ | | 0 | 0.2 | | 0.2 | |
| | | $V_{CC} = 4.5V; V_I = V_{IH}$ or $V_{IL}; I_O = 100\mu A$ | | 0 | 0.2 | | 0.2 | |
| V_{OL} | LOW level output voltage; STANDARD outputs | $V_{CC} = 3.0V; V_I = V_{IH}$ or $V_{IL}; I_O = 6mA$ | | 0.25 | 0.40 | | 0.50 | V |
| | | $V_{CC} = 4.5V; V_I = V_{IH}$ or $V_{IL}; I_O = 12mA$ | | 0.35 | 0.55 | | 0.65 | |
| V_{OL} | LOW level output voltage; BUS driver outputs | $V_{CC} = 3.0V; V_I = V_{IH}$ or $V_{IL}; I_O = 8mA$ | | 0.20 | 0.40 | | 0.50 | V |
| | | $V_{CC} = 4.5V; V_I = V_{IH}$ or $V_{IL}; I_O = 16mA$ | | 0.35 | 0.55 | | 0.65 | |
| I_I | Input leakage current | $V_{CC} = 5.5V; V_I = V_{CC}$ or GND | | | 1.0 | | 1.0 | μA |
| I_{OZ} | 3-State output OFF-state current | $V_{CC} = 5.5V; V_I = V_{IH}$ or $V_{IL}; V_O = V_{CC}$ or GND | | | 5 | | 10 | μA |

Quad 2-input NOR gate

74LV02

DC ELECTRICAL CHARACTERISTICS (Continued)

| SYMBOL | PARAMETER | TEST CONDITIONS | LIMITS | | | | | UNIT |
|------------------|--------------------------------------|---|----------------|-------------------|------|-----------------|------|------|
| | | | -40°C to +85°C | | | -40°C to +125°C | | |
| | | | MIN | TYP. ¹ | MAX | MIN | MAX | |
| I _{CC} | Quiescent supply current; SSI | V _{CC} = 5.5V; V _I = V _{CC} or GND; I _O = 0 | | | 20.0 | | 40 | μA |
| | Quiescent supply current; flip-flops | V _{CC} = 5.5V; V _I = V _{CC} or GND; I _O = 0 | | | 20.0 | | 80 | |
| I _{CC} | Quiescent supply current; MSI | V _{CC} = 5.5V; V _I = V _{CC} or GND; I _O = 0 | | | 20.0 | | 160 | μA |
| | Quiescent supply current; LSI | V _{CC} = 5.5V; V _I = V _{CC} or GND; I _O = 0 | | | 500 | | 1000 | |
| ΔI _{CC} | Additional quiescent supply current | V _{CC} = 2.7V to 3.6V; V _I = V _{CC} - 0.6V | | | 500 | | 850 | μA |

NOTE:

1. All typical values are measured at T_{amb} = 25°C.

AC CHARACTERISTICS

GND = 0V; t_r = t_f ≤ 2.5ns; C_L = 50pF; R_L = 1KΩ

| SYMBOL | PARAMETER | WAVEFORM | CONDITION | LIMITS | | | | | UNIT |
|------------------------------------|-----------------------------------|------------------|---------------------|---------------|-------------------|-----|----------------|-----|------|
| | | | | -40 to +85 °C | | | -40 to +125 °C | | |
| | | | | MIN | TYP. ¹ | MAX | MIN | MAX | |
| t _{PHL} /t _{PLH} | Propagation delay nA, nB to nY | Figures 1, 2 | V _{CC} (V) | | | | | | |
| | | | 1.2 | | 40 | | | | |
| | | | 2.0 | | 14 | 21 | | 26 | |
| | | | 2.7 | | 10 | 15 | | 19 | |
| | | | 3.0 to 3.6 | | 7.5 ² | 12 | | 15 | |
| 4.5 to 5.5 | | 6.0 ³ | 10 | | 13 | | | | |

NOTES:

1. Unless otherwise stated, all typical values are measured at T_{amb} = 25°C
2. Typical values are measured at V_{CC} = 3.3 V.
3. Typical values are measured at V_{CC} = 5.0 V.

AC WAVEFORMS

V_M = 1.5 V at V_{CC} ≥ 2.7 V and ≤ 3.6 V;

V_M = 0.5 × V_{CC} at < 2.7 V and ≥ 4.5 V;

V_{OL} and V_{OH} are the typical output voltage drop that occur with the output load.

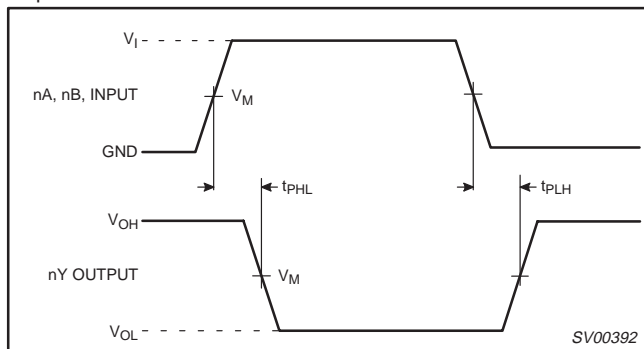


Figure 1. Input (nA, nB) to output (nY) propagation delays.

Quad 2-input NOR gate

74LV02

TEST CIRCUIT

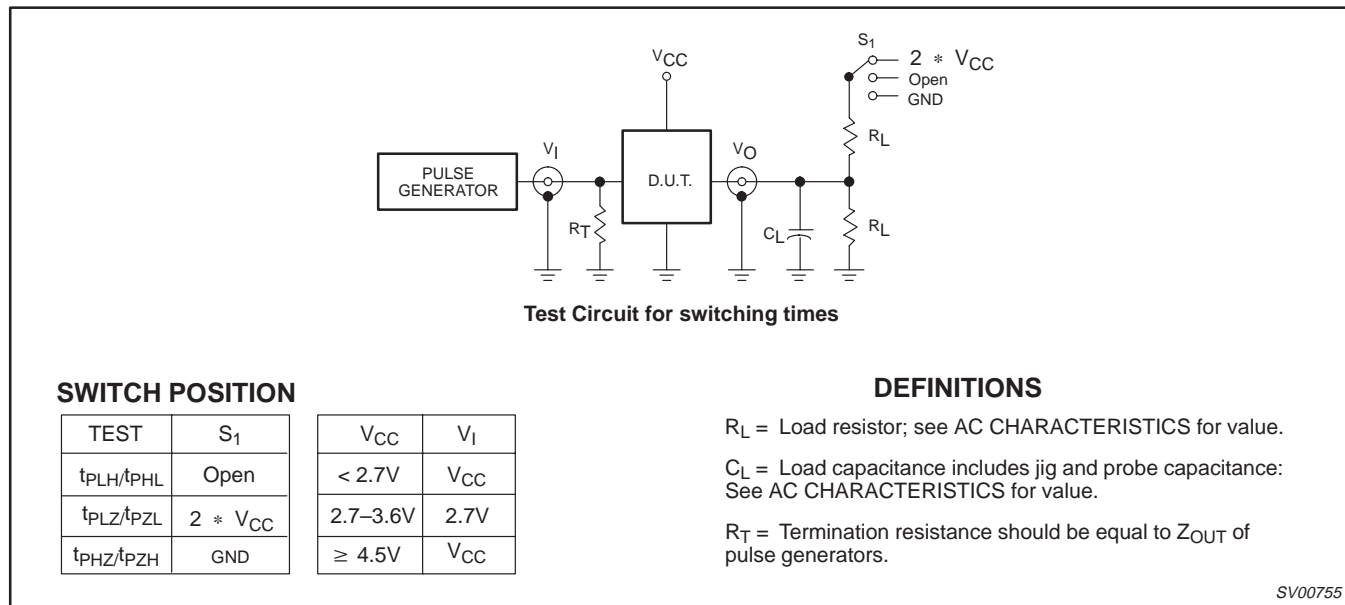


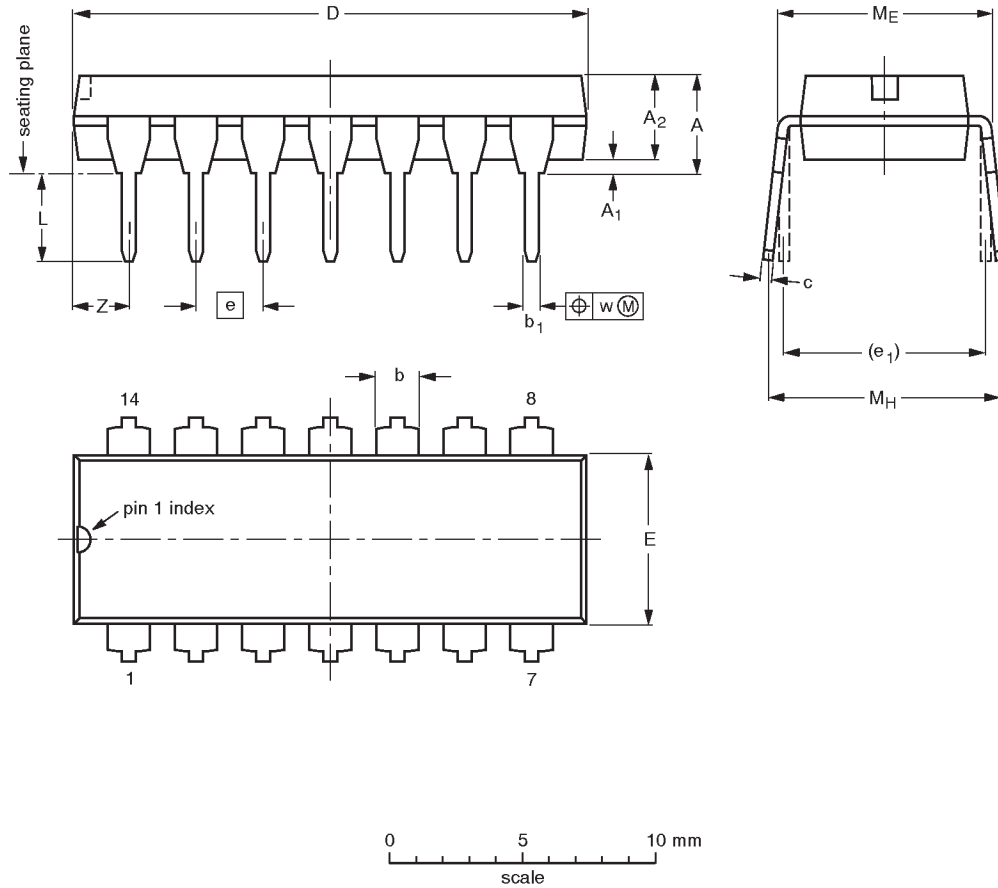
Figure 2. Load circuitry for switching times.

Quad 2-input NOR gate

74LV02

DIP14: plastic dual in-line package; 14 leads (300 mil)

SOT27-1



DIMENSIONS (inch dimensions are derived from the original mm dimensions)

| UNIT | A max. | A ₁ min. | A ₂ max. | b | b ₁ | c | D ⁽¹⁾ | E ⁽¹⁾ | e | e ₁ | L | M _E | M _H | w | Z ⁽¹⁾ max. |
|--------|--------|---------------------|---------------------|----------------|----------------|----------------|------------------|------------------|------|----------------|--------------|----------------|----------------|-------|-----------------------|
| mm | 4.2 | 0.51 | 3.2 | 1.73 1.13 | 0.53 0.38 | 0.36 0.23 | 19.50 18.55 | 6.48 6.20 | 2.54 | 7.62 | 3.60 3.05 | 8.25 7.80 | 10.0 8.3 | 0.254 | 2.2 |
| inches | 0.17 | 0.020 | 0.13 | 0.068 0.044 | 0.021 0.015 | 0.014 0.009 | 0.77 0.73 | 0.26 0.24 | 0.10 | 0.30 | 0.14 0.12 | 0.32 0.31 | 0.39 0.33 | 0.01 | 0.087 |

Note

1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

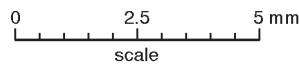
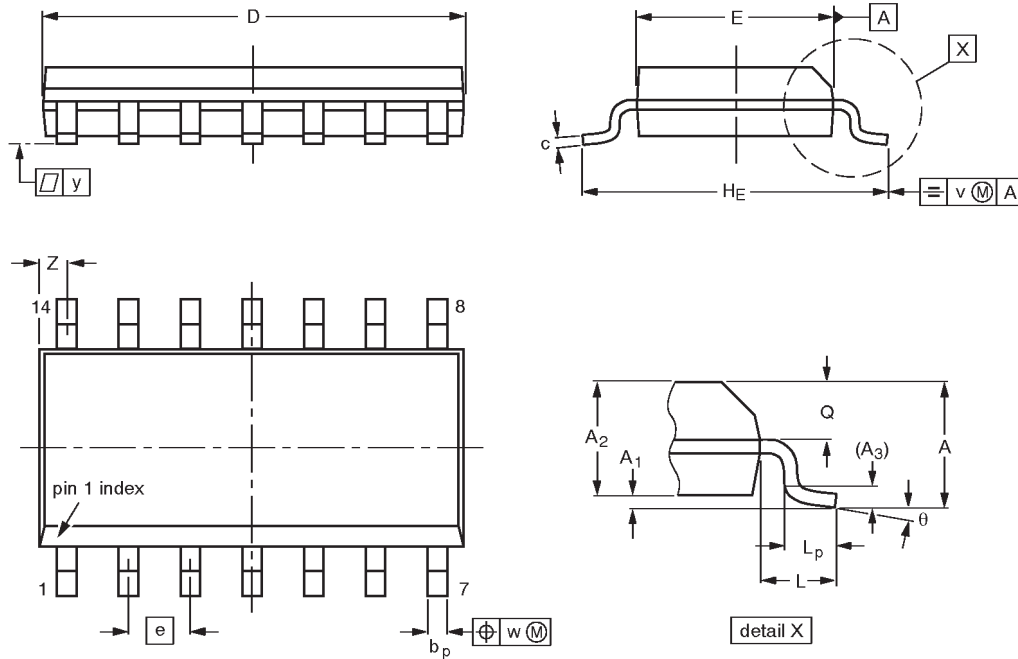
| OUTLINE VERSION | REFERENCES | | | EUROPEAN PROJECTION | ISSUE DATE |
|-----------------|------------|----------|------|---------------------|----------------------|
| | IEC | JEDEC | EIAJ | | |
| SOT27-1 | 050G04 | MO-001AA | | | 92-11-17 95-03-11 |

Quad 2-input NOR gate

74LV02

SO14: plastic small outline package; 14 leads; body width 3.9 mm

SOT108-1



DIMENSIONS (inch dimensions are derived from the original mm dimensions)

| UNIT | A max. | A ₁ | A ₂ | A ₃ | b _p | c | D ⁽¹⁾ | E ⁽¹⁾ | e | H _E | L | L _p | Q | v | w | y | Z ⁽¹⁾ | θ |
|--------|--------|------------------|----------------|----------------|----------------|------------------|------------------|------------------|-------|----------------|-------|----------------|----------------|------|------|-------|------------------|----------|
| mm | 1.75 | 0.25 0.10 | 1.45 1.25 | 0.25 | 0.49 0.36 | 0.25 0.19 | 8.75 8.55 | 4.0 3.8 | 1.27 | 6.2 5.8 | 1.05 | 1.0 0.4 | 0.7 0.6 | 0.25 | 0.25 | 0.1 | 0.7 0.3 | 8° 0° |
| inches | 0.069 | 0.0098 0.0039 | 0.057 0.049 | 0.01 | 0.019 0.014 | 0.0098 0.0075 | 0.35 0.34 | 0.16 0.15 | 0.050 | 0.24 0.23 | 0.041 | 0.039 0.016 | 0.028 0.024 | 0.01 | 0.01 | 0.004 | 0.028 0.012 | |

Note

1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.

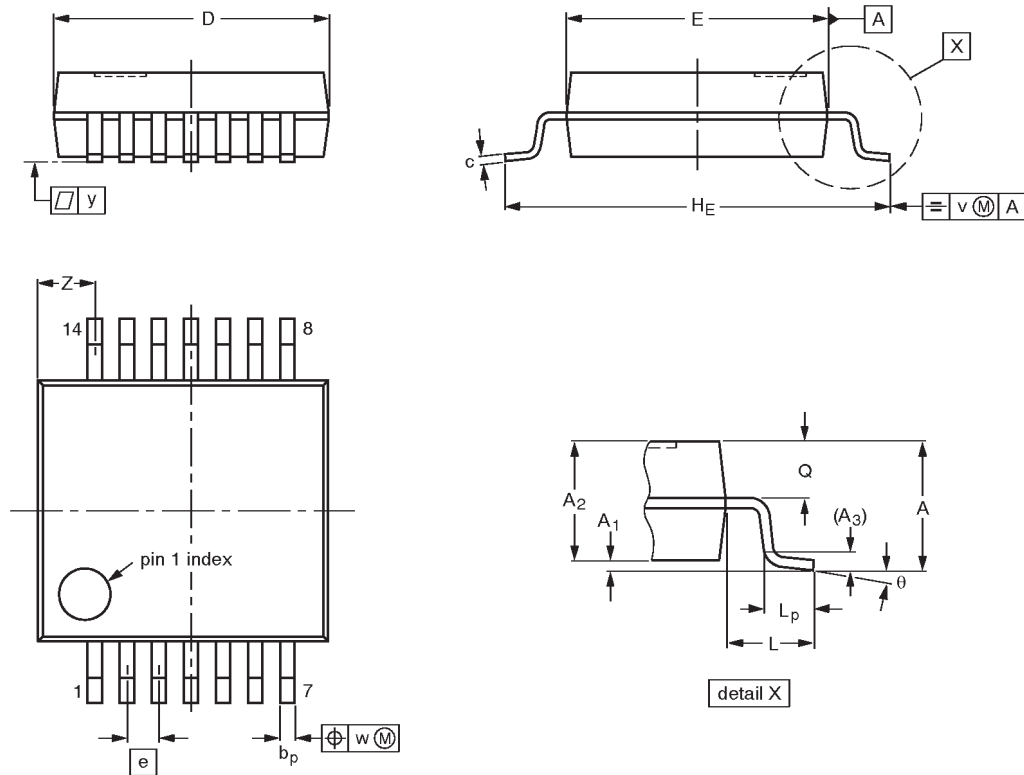
| OUTLINE VERSION | REFERENCES | | | | EUROPEAN PROJECTION | ISSUE DATE |
|-----------------|------------|----------|------|--|---------------------|----------------------|
| | IEC | JEDEC | EIAJ | | | |
| SOT108-1 | 076E06S | MS-012AB | | | | 91-08-13 95-01-23 |

Quad 2-input NOR gate

74LV02

SSOP14: plastic shrink small outline package; 14 leads; body width 5.3 mm

SOT337-1



DIMENSIONS (mm are the original dimensions)

| UNIT | A max. | A ₁ | A ₂ | A ₃ | b _p | c | D ⁽¹⁾ | E ⁽¹⁾ | e | H _E | L | L _p | Q | v | w | y | Z ⁽¹⁾ | θ |
|------|--------|----------------|----------------|----------------|----------------|--------------|------------------|------------------|------|----------------|------|----------------|------------|-----|------|-----|------------------|----------|
| mm | 2.0 | 0.21 0.05 | 1.80 1.65 | 0.25 | 0.38 0.25 | 0.20 0.09 | 6.4 6.0 | 5.4 5.2 | 0.65 | 7.9 7.6 | 1.25 | 1.03 0.63 | 0.9 0.7 | 0.2 | 0.13 | 0.1 | 1.4 0.9 | 8° 0° |

Note

1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

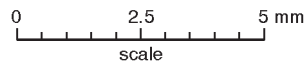
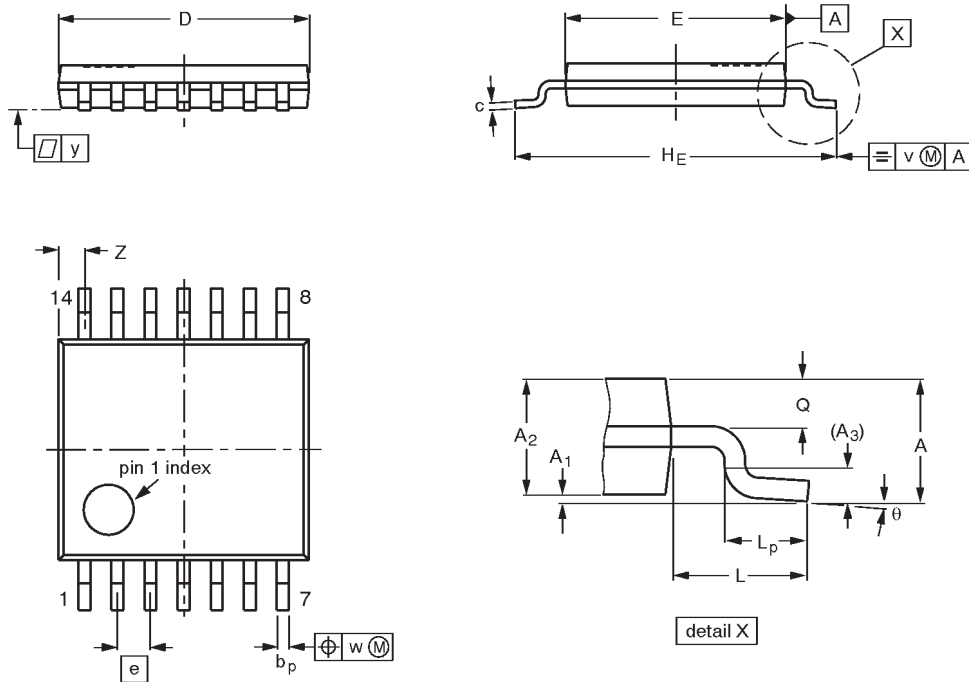
| OUTLINE VERSION | REFERENCES | | | | EUROPEAN PROJECTION | ISSUE DATE |
|-----------------|------------|----------|------|--|---------------------|---------------------------------|
| | IEC | JEDEC | EIAJ | | | |
| SOT337-1 | | MO-150AB | | | | 95-02-04 96-01-18 |

Quad 2-input NOR gate

74LV02

TSSOP14: plastic thin shrink small outline package; 14 leads; body width 4.4 mm

SOT402-1



DIMENSIONS (mm are the original dimensions)

| UNIT | A max. | A ₁ | A ₂ | A ₃ | b _p | c | D ⁽¹⁾ | E ⁽²⁾ | e | H _E | L | L _p | Q | v | w | y | Z ⁽¹⁾ | θ |
|------|--------|----------------|----------------|----------------|----------------|------------|------------------|------------------|------|----------------|-----|----------------|------------|-----|------|-----|------------------|----------|
| mm | 1.10 | 0.15 0.05 | 0.95 0.80 | 0.25 | 0.30 0.19 | 0.2 0.1 | 5.1 4.9 | 4.5 4.3 | 0.65 | 6.6 6.2 | 1.0 | 0.75 0.50 | 0.4 0.3 | 0.2 | 0.13 | 0.1 | 0.72 0.38 | 8° 0° |

Notes

1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

| OUTLINE VERSION | REFERENCES | | | | EUROPEAN PROJECTION | ISSUE DATE |
|-----------------|------------|--------|------|--|---------------------|------------------------|
| | IEC | JEDEC | EIAJ | | | |
| SOT402-1 | | MO-153 | | | | -94-07-12- 95-04-04 |

Quad 2-input NOR gate

74LV02

NOTES

Quad 2-input NOR gate

74LV02

DEFINITIONS

| Data Sheet Identification | Product Status | Definition |
|----------------------------------|-------------------------------|--|
| <i>Objective Specification</i> | Formative or in Design | This data sheet contains the design target or goal specifications for product development. Specifications may change in any manner without notice. |
| <i>Preliminary Specification</i> | Preproduction Product | This data sheet contains preliminary data, and supplementary data will be published at a later date. Philips Semiconductors reserves the right to make changes at any time without notice in order to improve design and supply the best possible product. |
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